

### **GRACE INERTIA 2.5**

TE Internal #: 1747067-4 PCB Mount Header, Vertical, Wire-to-Board, 4 Position, 2.5 mm [. 098 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, GRACE INERTIA 2.5

### View on TE.com >

#### Connectors > PCB Connectors > PCB Headers & Receptacles



Connector System: Wire-to-Board

Number of Positions: 4

Number of Rows: 1

Centerline (Pitch): 2.5 mm [.098 in]

PCB Mount Orientation: Vertical

# Features

**E** 

# Product Type Features

Connector System	Wire-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header
Configuration Features	
Number of Positions	4
Number of Rows	1
PCB Mount Orientation	Vertical
Electrical Characteristics	
Operating Voltage	50 VAC
Body Features	
Primary Product Color	Natural

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# **Contact Features**

PCB Contact Termination Area Plating Material Thickness	.8 μm[31.496 μin]
Contact Layout	Inline
Mating Tab Width	.7 mm[.028 in]
Mating Tab Thickness	.5 mm[.02 in]
Contact Underplating Material Thickness	1.27 μm[50 μin]
Contact Mating Area Plating Material Thickness	.3 μm[11.81 μin]
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Brass
Contact Mating Area Plating Material	Gold
Contact Type	Tab
Contact Current Rating (Max)	3 A
Termination Features	
Square Termination Post & Tail Dimension	.5 mm[.02 in]
Termination Post & Tail Length	3 mm[.118 in]

Termination Method to Printed Circuit Board

# Through Hole - Solder

### Mechanical Attachment

PCB Mount Alignment Type	Locating Posts
Mating Alignment Type	Polarization
Mating Retention	With
Panel Mount Feature	Without
PCB Mount Retention Type	Kinked
Mating Retention Type	Latch
Connector Mounting Type	Board Mount
Mating Alignment	With
PCB Mount Alignment	With
PCB Mount Retention	With
Housing Features	
Housing Material	Nylon
Centerline (Pitch)	2.5 mm[.098 in]
Dimensions	

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Connector Length	12.5 mm[.492 in]
Connector Height	.44 mm[11.3 in]
PCB Thickness (Recommended)	1.6 mm[.063 in]
Usage Conditions	
Operating Temperature Range	-30 – 105 °C[-22 – 221 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
Glow Wire Rating	Standard Part - Not Glow Wire
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	300
Packaging Type	Bag

# Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2	2011/65/EU
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### Compliant

EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Not applicable for solder process capability

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides

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on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# **Compatible Parts**



TE Part # 1747066-4 GRACE INERTIA CONN 2.5 PLUG HSG 4P NATUR



TE Part # 2-1747066-4 GRACE INERTIA CONN 2.5 PLUG HSG 4P BLUE



TE Part # 1827738-1 GIC 2.5 HDR ASSY SPECIAL 3/5P



GIC 2.5 W CAP HSG 4P BLUE





# Also in the Series | GRACE INERTIA 2.5



PCB Mount Header, Vertical, Wire-to-Board, 4 Position, 2.5 mm [.098 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, GRACE INERTIA 2.5





# Customers Also Bought



# Documents

Product Drawings GRACE INERTIA CONN 2.5 HDR ASSY 4P NAT

Japanese

### **CAD** Files

Customer View Model ENG\_CVM\_CVM\_1747067-4\_C.2d\_dxf.zip

English

# 3D PDF

3D

Customer View Model ENG\_CVM\_CVM\_1747067-4\_C.3d\_igs.zip

English

Customer View Model

ENG\_CVM\_CVM\_1747067-4\_C.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

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Product Specifications Application Specification

English